

Development Board Enclosures

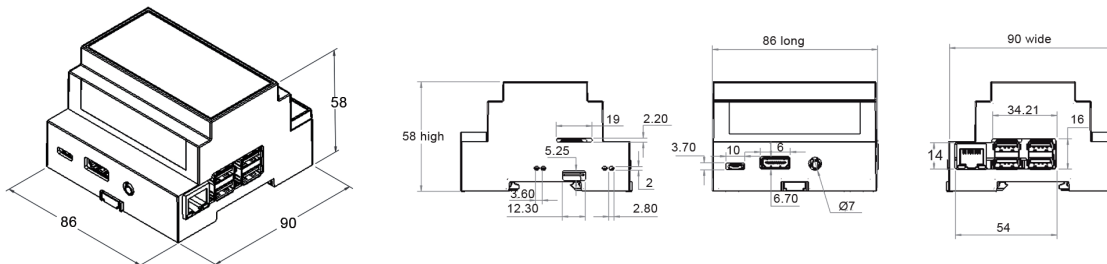
DIN Rail Pi B+ P2 P3 Enclosures



Features

- Designed to house the Raspberry Pi B+, P2, Pi3 via clip-in design, screws are not needed.
- All cut-outs are pre-cut into the case, no mods required
- High quality polycarbonate
- Moulded in PC (polycarbonate)
- DIN rail mountable
- I/O Connector can be accessed through the terminal guard
- Slot for display ribbon cable
- Wall mountable

Diagram



Part Number Table

Description	Colour	Part Number
Dev Board Enclosure, DIN Rail, Raspberry Pi Model B+, 2 Model B & 3 Model, Polycarbonate	Transparent	MC001475
	Grey	MC001476

Dimensions : Millimetres

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